

N-Channel Power MOSFET

600V, 0.6A, 5Ω

FEATURES

- Robust high voltage termination
- Avalanche energy specified
- · Diode is characterized for use in bridge circuits
- Source to Drain diode recovery time comparable to a discrete fast recovery diode.

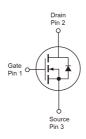
KEY PERFORMANCE PARAMETERS				
PARAMETER	ER VALUE UNIT			
V_{DS}	600	V		
R _{DS(on)} (max)	5	Ω		
Q_g	13	nC		

APPLICATION

- Power Supply
- Lighting
- Charger







Notes: Moisture sensitivity level: level 3. Per J-STD-020

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)				
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-Source Voltage		V_{DS}	600	V
Gate-Source Voltage		V_{GS}	±30	V
Continuous Drain Current (Note 1)	T _C = 25°C	1	0.6	^
	T _C = 100°C	I _D	0.36	_ A
Pulsed Drain Current (Note 2)	·	I _{DM}	1.5	Α
Total Power Dissipation @ T _C = 25°C		P _{DTOT}	2.5	W
Operating Junction Temperature		TJ	150	°C
Operating Junction and Storage Temperature Range		T _J , T _{STG}	- 55 to +150	°C

THERMAL PERFORMANCE				
PARAMETER	SYMBOL	LIMIT	UNIT	
Junction to Case Thermal Resistance	R _{eJC}	15	°C/W	
Junction to Ambient Thermal Resistance	R _{OJA}	55.8	°C/W	

Notes: $R_{\Theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistances. The case thermal reference is defined at the solder mounting surface of the drain pins. $R_{\Theta JA}$ is guaranteed by design while $R_{\Theta CA}$ is determined by the user's board design. $R_{\Theta JA}$ shown below for single device operation on FR-4 PCB in still air



ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)						
PARAMETER	CONDITIONS	SYMBOL	MIN	TYP	МАХ	UNIT
Static (Note 3)						
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	BV _{DSS}	600			V
Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	V _{GS(TH)}	2		4	V
Gate Body Leakage	V_{GS} =±30V, V_{DS} =0V	I _{GSS}			±100	nA
Zero Gate Voltage Drain Current	V _{DS} =600V, V _{GS} =0V	I _{DSS}			1	μA
Drain-Source On-State Resistance	$V_{GS} = 10V, I_D = 0.6A$	R _{DS(ON)}		3.6	5	Ω
Forward Transconductance	$V_{DS} = 10V, I_{D} = 0.2A$	g _{fs}		0.8		S
Dynamic (Note 4)						
Total Gate Charge	V _{DS} =400V, I _D =0.6A, V _{GS} = 10V	Q_g		13		
Gate-Source Charge		Q_{gs}		2		nC
Gate-Drain Charge		Q_{gd}		6		
Input Capacitance	V _{DS} =25V, V _{GS} =0V, f =1.0MHz	C _{iss}		435		
Output Capacitance		C _{oss}		56		pF
Reverse Transfer Capacitance	1 - 1.0WI 12	C _{rss}		9.2		
Switching (Note 5)						
Turn-On Delay Time	V_{GS} =10V, I_{D} =0.6A, V_{DD} =300V, R_{G} =18 Ω ,	t _{d(on)}		12		
Turn-On Rise Time		t _r		21		
Turn-Off Delay Time		t _{d(off)}		30		ns
Turn-Off Fall Time		t _f		24		
Source-Drain Diode (Note 3)						
Forward On Voltage	I _S = 8A, V _{GS} = 0V	V_{SD}		0.85	1.15	V

Notes:

- 1. Current limited by package
- 2. Pulse width limited by the maximum junction temperature
- 3. Pulse test: PW ≤ 300µs, duty cycle ≤ 2%
- 4. For DESIGN AID ONLY, not subject to production testing.
- 5. Switching time is essentially independent of operating temperature.





ORDERING INFORMATION

PART NO.	PACKAGE	PACKING
TSM2N60SCW RPG	SOT-223	2,500pcs / 13" Reel

Note:

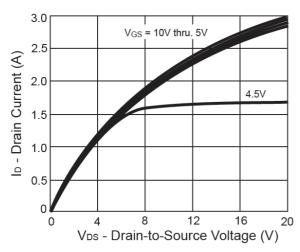
- 1. Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- 2. Halogen-free according to IEC 61249-2-21 definition



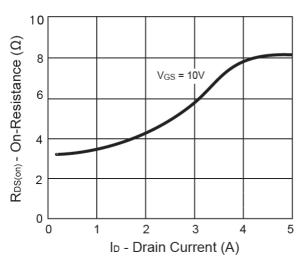
CHARACTERISTICS CURVES

 $(T_C = 25^{\circ}C \text{ unless otherwise noted})$

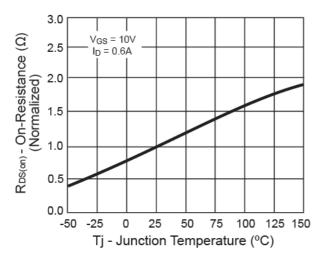
Output Characteristics



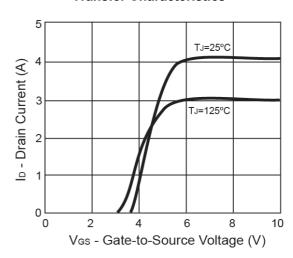
On-Resistance vs. Drain Current



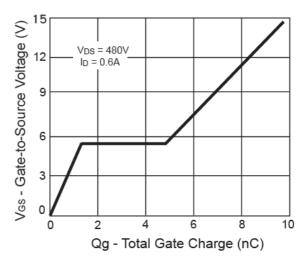
On-Resistance vs. Junction Temperature



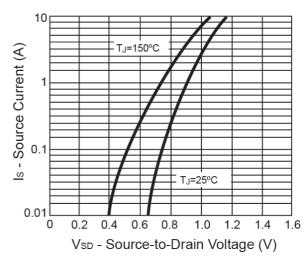
Transfer Characteristics



Gate Charge



Source-Drain Diode Forward Voltage

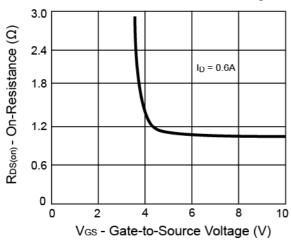




CHARACTERISTICS CURVES

(Tc = 25°C unless otherwise noted)

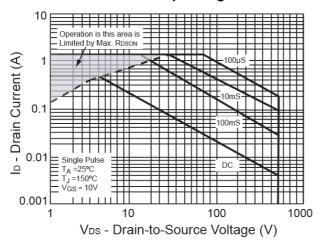
On-Resistance vs. Gate-Source Voltage



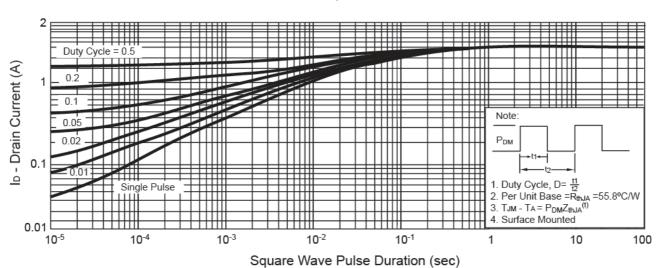
Threshold Voltage 1.3 Vos(th) - Gate Threshold Voltage 1.2 1.1 $I_D = 250 \mu A$ (Normalized) 1.0 0.9 0.8 0.7 0.6 0.5 -50 -25 25 50 75 100 125 150

Tj - Junction Temperature (°C)

Maximum Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient

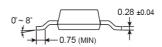




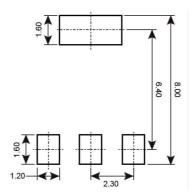
PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)

SOT-223 6.5 ±0.20 3.0 ±0.10 3.0 ±0.10 2.3 (REF) 0.725 ±0.125





SUGGESTED PAD LAYOUT



MARKING DIAGRAM



Y = Year Code

M = Month Code for Halogen Free Product

O =Jan P =Feb Q =Mar R =Apr

S =May T =Jun U =Jul V =Aug

W =Sep X =Oct Y =Nov Z =Dec

L = Lot Code (1~9, A~Z)



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